Product data sheet

1. General description

Silicon Carbide Schottky diode in a TO247-2L plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- · Highly stable switching performance
- High forward surge capability I_{FSM}
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- · Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability (T_{i(max)} = 175 °C)

3. Applications

- · Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes	Values		Unit	
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage			1200		V	
$\mathbf{I}_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 112 °C; Fig. 1; Fig. 2; Fig. 3		20		Α	
T_j	junction temperature			-55 to 175		°C	
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static characteristics							
V _F	forward voltage	I _F = 20 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.54	1.75	V
		I _F = 20 A; T _j = 150 °C; <u>Fig. 5</u>		-	2.15	2.60	V
		I _F = 20 A; T _j = 175 °C; <u>Fig. 5</u>		-	2.35	2.80	V
Dynamic	characteristics						
Q _r	recovered charge	$I_F = 20 \text{ A}$; $dI_F/dt = 500 \text{ A/}\mu\text{s}$; $V_R = 400 \text{ V}$; $T_i = 25 ^{\circ}\text{C}$; Fig. 7		-	36	-	nC

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		v 14 A
2	А	anode		K — A 001aaa020
mb	mb	mounting base; connected to cathode	K A TO247-2L	

6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WNSC2D201200W-B	TO247-2L	WNSC2D201200W-B6Q	Tube	30	TO247L-2L	10-Nov-2020

7. Marking

Table 4. Marking codes

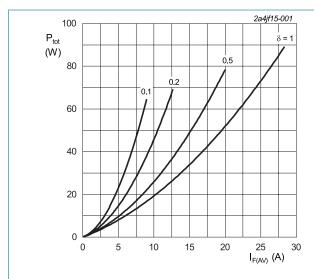
- table is marring course	
Type number	Marking codes
WNSC2D201200W-B	WNSC2D 201200W-B

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V_{RRM}	repetitive peak reverse voltage			1200	V
V_{RWM}	crest working reverse voltage			1200	V
V_R	reverse voltage	DC		1200	V
I _{F(AV)}	average forward current	δ = 0.5; square-wave pulse; $T_{mb} \le$ 112 °C; Fig. 1; Fig. 2; Fig. 3		20	А
I_{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 112 °C; square-wave pulse		40	А
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		140	А
	forward current	$t_p = 10 \mu s; T_{j(init)} = 25 °C; square-wave pulse$		900	Α
l ² t	I ² t for fusing	sine-wave pulse; $T_{j(init)} = 25 \text{ °C}$; $t_p = 10 \text{ ms}$		98	A ² s
T _{stg}	storage temperature			-55 to 175	°C
T _j	junction temperature			-55 to 175	°C



$$\begin{split} I_{\text{F(AV)}} &= I_{\text{F(RMS)}} \times \sqrt{\delta} \\ V_{\text{o}} &= 1.268 \text{ V; } R_{\text{s}} = 0.0662 \text{ } \Omega \end{split}$$

Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

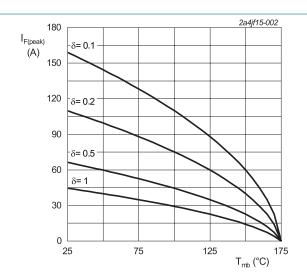
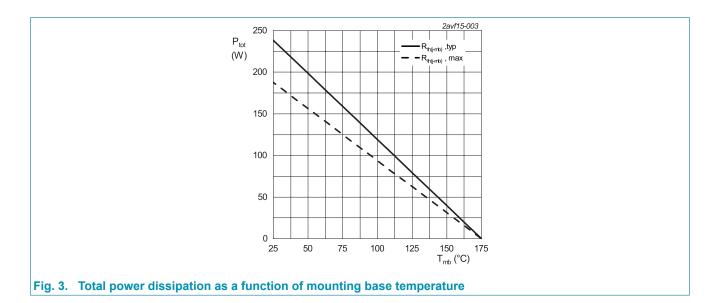


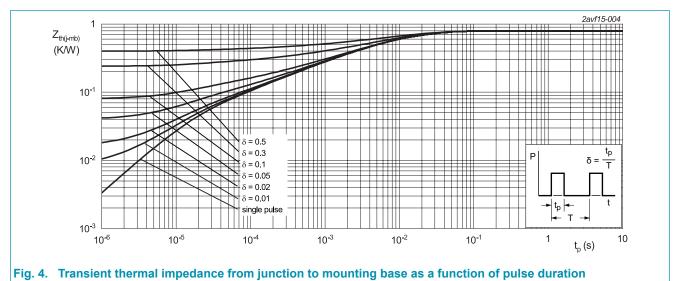
Fig. 2. Current derating as a function of mounting base temperature



9. Thermal characteristics

Table 6. Thermal characteristics

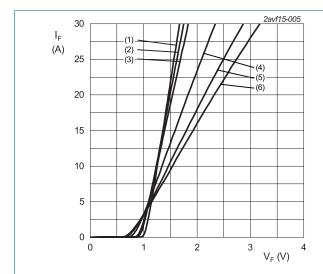
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 4		-	0.63	0.8	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air		-	40	-	K/W



10. Characteristics

Table 7. Characteristics

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Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics						
V _F	forward current	$I_F = 20 \text{ A}; T_j = 25 \text{ °C}; Fig. 5$		-	1.54	1.75	V
		I _F = 20 A; T _j = 150 °C; <u>Fig. 5</u>		-	2.15	2.60	V
		I _F = 20 A; T _j = 175 °C; <u>Fig. 5</u>		-	2.35	2.80	V
I _R	reverse current	V _R = 1200 V; T _j = 25 °C; <u>Fig. 6</u>		-	1	75	μA
		V _R = 1200 V; T _j = 175 °C; <u>Fig. 6</u>		-	25	-	μA
Dynamic	characteristics						
Q_r	recovered charge	$I_F = 20 \text{ A}$; $V_R = 400 \text{ V}$; $dI_F/dt = 500 \text{ A/}\mu\text{s}$; $T_j = 25 ^{\circ}\text{C}$; Fig. 7		-	36	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C		-	800	-	pF
		f = 1 MHz; V _R = 400 V; T _j = 25 °C		-	66	-	pF
		f = 1 MHz; V _R = 800 V; T _j = 25 °C		-	48	-	pF
E _{as}	non-repetitive avalanche energy	$I_R = 4.7 \text{ A}$; L = 10 mH; $T_{j(init)} = 25 ^{\circ}\text{C}$		110	-	-	mJ



 V_{o} = 1.268 V; R_{s} = 0.0662 Ω

(1) $T_i = -55$ °C; typical values

(2) $T_i = 0$ °C; typical values

(3) T_j = 25 °C; typical values

(4) $T_j = 100 \,^{\circ}\text{C}$; typical values

(5) $T_j = 150$ °C; typical values (6) $T_j = 175$ °C; typical values

Fig. 5. Forward current as a function of forward voltage; typical values

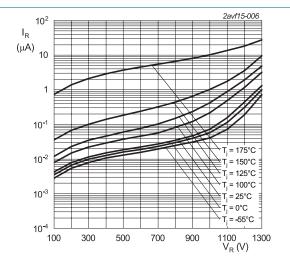


Fig. 6. Reverse leakage current as a function of reverse voltage; typical value

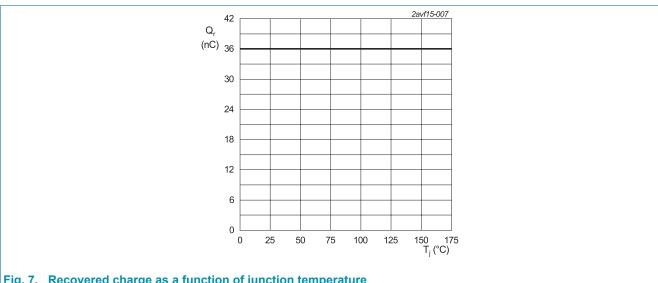
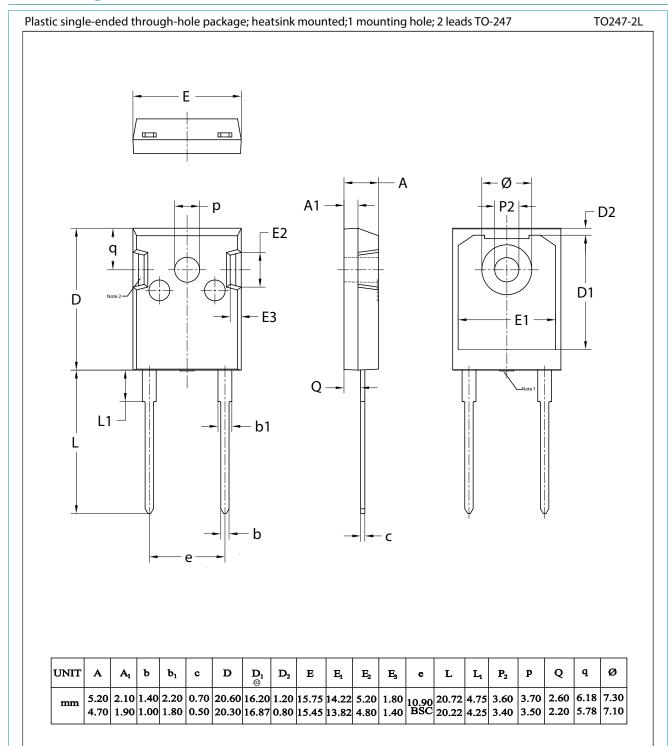


Fig. 7. Recovered charge as a function of junction temperature

11. Package outline



Note:

- 1. Mold resin protrusion max 0.127mm.
- 2. Metal exposed with Sn plating.

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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